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Docket No.:501.39150X00 JC02 Rec'd PCT/PTO 2 3 FEB 200

ECORDATION FORM COVER SHEET

PATENTS ONLY

101692637ents and Trademarks: Plea	se record the attached original documents or copy thereof.	
1. Name of conveying party(ies): Hidehiro OKADA, Tetsuya MARUYAMA	Name and address of receiving party(ies): Name: Hitachi, Ltd.	
	Street Address: 6, Kanda Surugadai 4-chome, Chiyoda-ku	
Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of conveyance: Assignment Merger	City: Tokyo: 09713495	
Security Agreement Change of Name Other	Country: Japan	
Execution Date: September 6, 7, 2000	Additional name(s) & address(es) attached? Yes X No	
4. Application number(s) or patent number(s):		
If this document is being filed together with a new application, to A. Patent Application No.(s)	the execution date of the application is: September 6,7, 2000 B. Patent No.(s)	
Additional numbers atta	ched? Yes X No	
 Name and address of party to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved: 1	
Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP	7. Total fee (37 CFR 3.41)\$4().00	
Internal Address:	Enclosed Any deficiencies may be charged to deposit account Authorized to be charged to deposit account	
Street Address: 1300 North Seventeenth Street	8. Deposit account number: 01-2135	
Suite 1800 City: Arlington State: VA Zip: 22209	(Attach duplicate copy of this page if paying by deposit account)	
City. Aimigton	E THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing into of the original document. Gregory E. Montone Name of Person Signing Attorney Registration No. 28,141 Total number of pages including cover sheet, attachments, and document: 2 OMB No. 0651-0011 (exp. 4/94)	formation is true and correct and any attached copy is a true copy February 23, 2001 Date	
Olyld No. 0051-0011 (chp)		

PATENT REEL: 011727 FRAME: 0747

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR INTEGRATED CIRCUIT

invented by me—(if only one is named below) or us—(if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner-ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed (署名日)

1)	Hidehiro Okcuda Tetsuya Maruyama	(Hidehiro OKADA) (Tetsuya MARUYAMA)	6/September/2000
8)			
9)			
10)	,		

PATENT
RECORDED: 02/23/2001 REEL: 011727 FRAME: 0748